

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Hyeng-cheul CHOI</td> <td>03/31/2011</td> </tr> <tr> <td>Jaeseok LEE</td> <td>03/31/2011</td> </tr> <tr> <td>Oul CHO</td> <td>03/31/2011</td> </tr> <tr> <td>Hyungjin LEE</td> <td>03/31/2011</td> </tr> <tr> <td>Bumki PARK</td> <td>03/31/2011</td> </tr> </tbody> </table>		Name	Execution Date	Hyeng-cheul CHOI	03/31/2011	Jaeseok LEE	03/31/2011	Oul CHO	03/31/2011	Hyungjin LEE	03/31/2011	Bumki PARK	03/31/2011
Name	Execution Date												
Hyeng-cheul CHOI	03/31/2011												
Jaeseok LEE	03/31/2011												
Oul CHO	03/31/2011												
Hyungjin LEE	03/31/2011												
Bumki PARK	03/31/2011												
RECEIVING PARTY DATA													
Name:	RADINA CO., LTD												
Street Address:	701, SK Apartment Factory, 16-4, Seongsu-dong, Seongdong-gu												
City:	Seoul												
State/Country:	REPUBLIC OF KOREA												
Postal Code:	113-110												
PROPERTY NUMBERS Total: 1													
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13081014</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	13081014								
Property Type	Number												
Application Number:	13081014												
CORRESPONDENCE DATA													
Fax Number:	(703)935-8473												
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>													
Phone:	571-313-7556												
Email:	mail@sherr-law.com												
Correspondent Name:	SHERR & VAUGHN, PLLC												
Address Line 1:	620 HERNDON PARKWAY												
Address Line 2:	SUITE 320												
Address Line 4:	HERNDON, VIRGINIA 20170												
ATTORNEY DOCKET NUMBER:	546-0010												
NAME OF SUBMITTER:	Kyung Hee Kim												
Total Attachments: 3 source=20110406151812#page1.tif source=20110406151812#page2.tif source=20110406151812#page3.tif													

OP \$40.00 13081014

SHERR & VAUGHN, PLLC

620 Herndon Parkway, Suite 320
Herndon, VA 20170
Tel 571 313 7556 | Fax 703 935 8473

**UNITED STATES PATENT RIGHTS, OR
UNITED STATES PLUS ALL FOREIGN PATENT RIGHTS**

ASSIGNMENT

Application No. 13/081,014 Filing Date 04/06/2011

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned:

1) CHOI, Hyeng-cheul residing at 1801ho 226dong, Ricenz Apt.,
Jamsil 2-dong, Songpa-gu, Seoul 138-912, Republic of Korea

2) LEE, Jaeseok residing at 84-23, Sanggye-dong,
Nowon-gu, Seoul 139-200, Republic of Korea

3) CHO, Oul residing at 806ho 6dong, Samsung 2Cha Apt.,
Maetan 4-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do 443-719, Republic of Korea

4) LEE, Hyungjin residing at 1502ho 103dong, Bonheur Village Apt.,
Gojan 1-dong, Danwon-gu, Ansan-si, Gyeonggi-do 425-806, Republic of Korea

5) PARK, Bumki residing at 203ho 121dong, Daewoo Purgio Apt.,
Miseong-dong, Gwanak-gu, Seoul 151-772, Republic of Korea

6) _____ residing at _____

7) _____ residing at _____

who has made certain new and useful inventions, hereby sell, assign and transfer unto
RADINA CO., LTD

having an address at

701, SK Apartment Factory, 16-4, Seongsu-dong 1-ga, Seongdong-gu, Seoul 113-110,
Republic of Korea

its heirs, successors, legal representatives and assigns (hereinafter designated
"ASSIGNEE") the entire right, title and interest for the United States of America as
defined in 35 U.S.C. 100 in the invention entitled

GROUND RADIATION ANTENNA

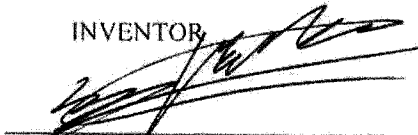



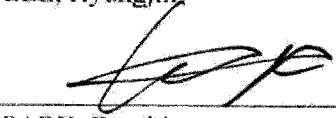
for which an application for a United States Patent was filed on 04/06/2011,
identified as U.S. Patent Serial Number 13/081,014
and the undersigned hereby authorize and request the United States Commissioner of
Patents and Trademarks to issue any and all United States Letters Patent which may be
granted therefore and/or that claim priority thereto and any and all extensions, divisions,
reissues, substitutes, renewals, continuations, or continuations-in-part thereof and/or that
claim priority thereto, and the right to all benefits under the International Convention for
the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE,
its heirs, successors, assigns and legal representatives; the undersigned agree that the
attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree to transfer a like interest, and to render all
necessary assistance in making application for and obtaining original, divisional, reissued
or extended Letters Patent of the United States, and associated foreign patent applications,
upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and
without further remuneration, in and to any improvements, and applications for patent
based thereon, growing out of or related to the said invention; and to execute any papers
by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential

to ASSIGNEE's full protection and title in and to the invention hereby transferred.

AND the undersigned hereby grants the firm of SHERR & VAUGHN, PLLC the power to insert on this assignment any further identification that may be necessary or desirable in order to comply with the rules of any issuing authority, including the United States Patent and Trademark Office, for recordation of this document.

SIGNED on the dates indicated aside our signatures:

	INVENTOR	DATE
1)	 CHOI, Hyong-cheul	Mar 31, 2011
2)	 LEE, Jaeseok	Mar 31, 2011
3)	 CHO, Oul	Mar 31, 2011
4)	 LEE, Hyungjin	Mar 31, 2011
5)	 PARK, Bumki	Mar 31, 2011
6)	_____	
7)	_____	